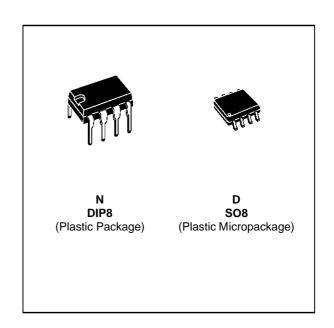


TS912

INPUT/OUTPUT RAIL TO RAIL **DUAL CMOS OPERATIONAL AMPLIFIER**

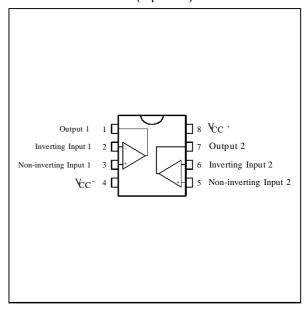
- RAIL TO RAIL INPUT AND OUTPUT **VOLTAGE RANGES**
- SINGLE (OR DUAL) SUPPLY OPERATION FROM **2.7V TO 16V** (±1.35V to ±8V)
- EXTREMELY LOW INPUT BIAS CURRENT: 1pA TYP
- LOW INPUT OFFSET VOLTAGE: 2mV max.
- SPECIFIED FOR 600Ω AND 100Ω LOADS
- LOW SUPPLY CURRENT: 400µA/Ampli
- SPEED: 1.4MHz 1.3V/µs
- ESD TOLERANCE: 3KV
- LATCH-UP IMMUNITY
- SPICE MACROMODEL INCLUDED IN THIS **SPECIFICATION**



ORDER CODES

Part Number	Temperature Range	Package		
i ait itallibei	remperature Mange	N	D	
TS912I/AI/BI	-40, +125°C	•	•	

PIN CONNECTIONS (top view)



DESCRIPTION

The TS912 is a RAIL TO RAIL dual CMOS operational amplifier designed to operate with single or dual supply voltage.

The input voltage range V_{icm} includes the two supply rails V_{CC}⁺ and V_{CC}.

The output reaches:

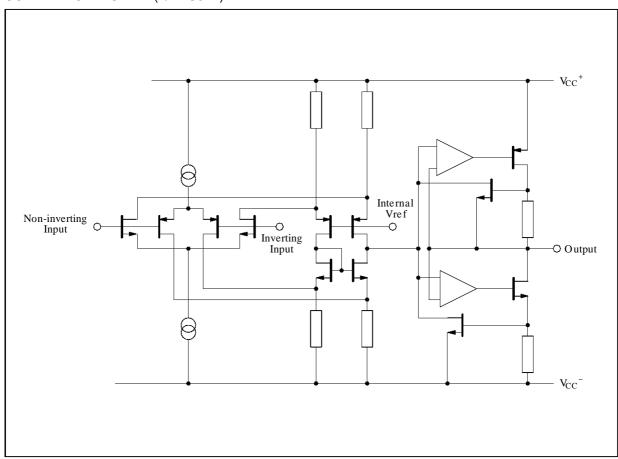
- $\begin{array}{lll} \bullet & V_{CC} + 50 mV & V_{CC} ^+ 50 mV & with \ R_L = 10 k\Omega \\ \bullet & V_{CC} ^- + 650 mV & V_{CC} ^+ 650 mV & with \ R_L = 600\Omega \end{array}$ with $R_L = 10k\Omega$

This product offers a broad supply voltage operating range from 2.7V to 16V, a supply current of only 400μ A/amp (V_{CC} = 10V) and a high output current capability fixed by an internal limitation circuit:

 $I_{source} = 65 \text{mA} - I_{sink} = 75 \text{mA}$

March 1996 1/10

SCHEMATIC DIAGRAM (1/2 TS912)



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage - (note 1)	18	V
V _{id}	Differential Input Voltage - (note 2)	±18	V
Vi	Input Voltage - (note 3)	-0.3 to 18	V
I _{in}	Current on Inputs	±50	mA
lo	Current on Outputs	±130	mA
T _{oper}	Operating Free Air Temperature Range TS912I/AI/BI	-40 to +125	°C
T _{stg}	Storage Temperature	-65 to +150	°C

Notes:

All voltage values, except differential voltage are with respect to network ground terminal.
 Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
 The magnitude of input and output voltages must never exceed V_{CC}⁺ +0.3V.

OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	2.7 to 16	V
V _{icm}	Common Mode Input Voltage Range	V _{CC} ⁻ -0.2 to V _{CC} ⁺ +0.2	V



ELECTRICAL CHARACTERISTICS

 $V_{CC}^+ = 10V$, $V_{CC}^- = 0V$, R_L , C_L connected to $V_{CC}/2$, $T_{amb} = 25^{\circ}C$ (unless otherwise specified)

Symbol	Parameter			TS912I/AI/BI		
Symbol	Parameter	Min.	Тур.	Max.	Unit	
V _{io}	Input Offset Voltage ($V_{ic} = V_o = V_{CC}/2$) $T_{min.} \le T_{amb} \le T_{max}.$	TS912 TS912A TS912B TS912 TS912A TS912B			10 5 2 12 7 3	mV
DV _{io}	Input Offset Voltage Drift			5		μV/°C
l _{io}	Input Offset Current - (note 1) $T_{min.} \le T_{amb} \le T_{max.}$			1	100 200	pA
I _{ib}	Input Bias Current - (note 1) $T_{min.} \le T_{amb} \le T_{max.}$			1	150 300	pA
Icc	Supply Current (per amplifier, $A_{VCL} = 1$, no $T_{min.} \le T_{amb} \le T_{max.}$		400	600 700	μΑ	
CMR	Common Mode Rejection Ratio	60 50	90 75		dB	
SVR	Supply Voltage Rejection Ratio (V_{CC}^+ = 5 to 10V, $V_O = V_{CC}$ /2)			90		dB
A_{vd}	Large Signal Voltage Gain (R _L = $10k\Omega$, V _O = $2.5V$ to $7.5V$) $T_{min.} \le T_{amb} \le T_{max.}$			60		V/mV
V _{ОН}	High Level Output Voltage (V _{id} = 1V)	$R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$	9.95 9.85 9	9.95 9.35 7.8		V
	$T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 10k\Omega$ $R_L = 600\Omega$	9.8 8.8			
V _{OL}	Low Level Output Voltage (V _{id} = -1V)	$R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$		50 650 2300	50 150 800	mV
	$T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 10k\Omega$ $R_L = 600\Omega$			150 900	
lo	Output Short Circuit Current ($V_{id} = \pm 1V$)			65 75		mA
GBP	Gain Bandwidth Product $(A_{VCL} = 100, R_L = 10k\Omega, C_L = 100pF, f = 100kHz)$			1.4		MHz
SR ⁺	Slew Rate (A _{VCL} = 1, R _L = $10k\Omega$, C _L = $100pF$, V _i = $2.5V$ to $7.5V$)			1.3		V/μs
SR	Slew Rate (A _{VCL} = 1, R _L = $10k\Omega$, C _L = $100p$	$F, V_i = 2.5V \text{ to } 7.5V)$		0.8		V/μs
Øm	Phase Margin			40		Degrees
e _n	Equivalent Input Noise Voltage ($R_s = 100\Omega$, f = 1kHz)		30		$\frac{\text{nV}}{\sqrt{\text{Hz}}}$
THD	Total Harmonic Distortion $(A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_O = 4.75V \text{ to } 5.25V, f = 1kHz)$			0.024		%
Cin	Input Capacitance			1.5		pF
V _{O1} /V _{O2}	Channel Separation (f = 1kHz)			120		dB

Note 1: Maximum values including unavoidable inaccuracies of the industrial test.

TYPICAL CHARACTERISTICS

Figure 1: Supply Current (each amplifier) versus Supply Voltage

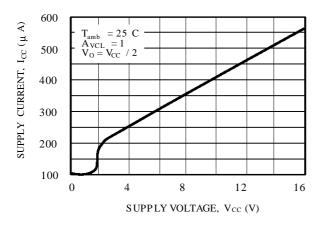


Figure 3a: High Level Output Voltage versus High Level Output Current

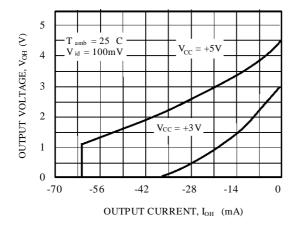


Figure 4a: Low Level Output Voltage versus Low Level Output Current

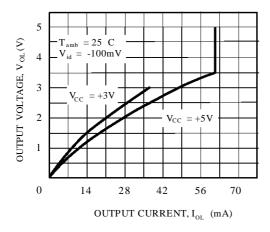


Figure 2: Input Bias Current versus Temperature

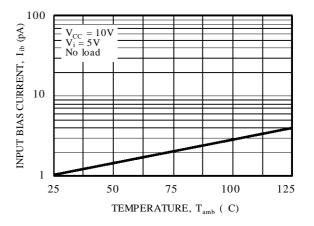


Figure 3b : High Level Output Voltage versus High Level Output Current

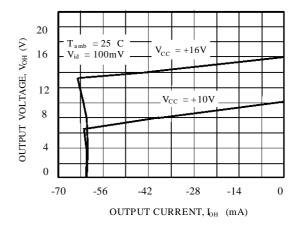
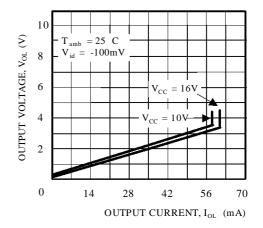


Figure 4b : Low Level Output Voltage versus Low Level Output Current



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Figure 5a: Open Loop Frequency Response and Phase Shift

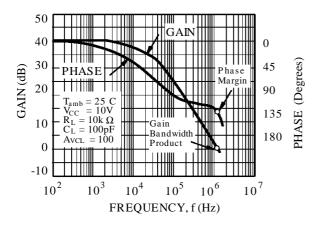


Figure 6a : Gain Bandwidth Product versus Supply Voltage

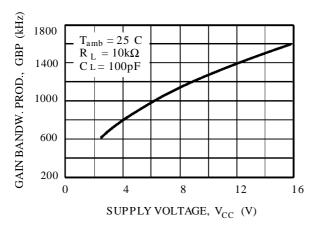


Figure 7a: Phase Margin versus Supply Voltage

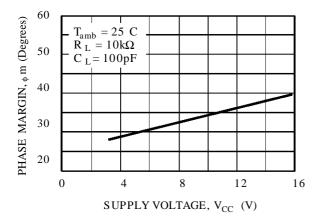


Figure 5b : Open Loop Frequency Response and Phase Shift

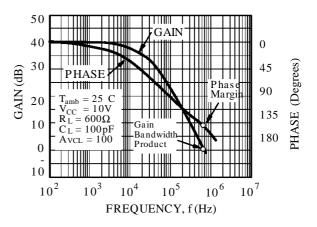


Figure 6b : Gain bandwidth Product versus Supply Voltage

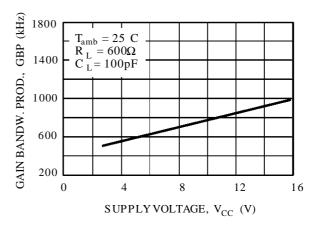
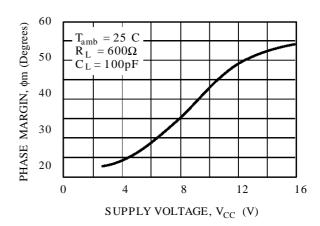


Figure 7b: Phase Margin versus Supply Voltage



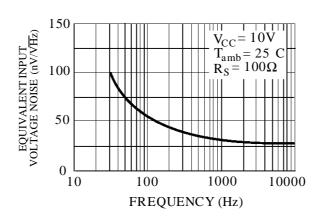
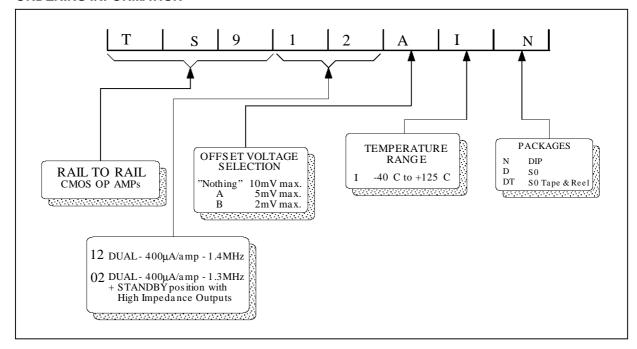


Figure 8: Input Voltage Noise versus Frequency

ORDERING INFORMATION



MACROMODEL

- RAIL TO RAIL INPUT AND OUTPUT VOLT-AGE RANGES
- SINGLE (OR DUAL) SUPPLY OPERATION FROM 2.7V TO 16V (±1.35V to ±8V)
- EXTREMELY LOW INPUT BIAS CURRENT : 1pA typ.
- LOW INPUT OFFSET VOLTAGE: 2mV max.
- SPECIFIED FOR $\mathbf{600}\Omega$ AND $\mathbf{100}\Omega$ LOADS
- LOW SUPPLY CURRENT: 400µA/Ampli
- SPEED: 1.4MHz 1.3V/µs

Applies to: TS912I,AI

** Standard Linear Ics Macromodels, 1993.

** CONNECTIONS:

* 1 INVERTING INPUT

* 2 NON-INVERTING INPUT

* 3 OUTPUT

* 4 POSITIVE POWER SUPPLY

* 5 NEGATIVE POWER SUPPLY

.SUBCKT TS912 1 3 2 4 5 (analog)

.MODEL MDTH D IS=1E-8 KF=6.563355E-14 CJO=10F

* INPUT STAGE

CIP 2 5 1.500000E-12

CIN 1 5 1.500000E-12

EIP 10 5 2 5 1

EIN 165151

RIP 10 11 6.500000E+00

RIN 15 16 6.500000E+00

RIS 11 15 7.655100E+00

DIP 11 12 MDTH 400E-12

DIN 15 14 MDTH 400E-12

VOFP 12 13 DC 0.000000E+00

VOFN 13 14 DC 0

IPOL 13 5 4.000000E-05

CPS 11 15 3.82E-08

DINN 17 13 MDTH 400E-12

VIN 17 5 -0.5000000e+00

DINR 15 18 MDTH 400E-12

VIP 4 18 -0.5000000E+00

FCP 4 5 VOFP 7.750000E+00

FCN 5 4 VOFN 7.750000E+00

* AMPLIFYING STAGE

FIP 5 19 VOFP 5.500000E+02

FIN 5 19 VOFN 5.500000E+02

RG1 19 5 5.087344E+05

RG2 19 4 5.087344E+05

CC 19 29 2.200000E-08

HZTP 30 29 VOFP 12.33E+02

HZTN 5 30 VOFN 12.33E+02

DOPM 19 22 MDTH 400E-12

DONM 21 19 MDTH 400E-12

HOPM 22 28 VOUT 3135

VIPM 28 4 150

HONM 21 27 VOUT 3135

VINM 5 27 150

EOUT 26 23 19 5 1

VOUT 23 5 0

ROUT 26 3 65

COUT 3 5 1.000000E-12

DOP 19 68 MDTH 400E-12

VOP 4 25 1.924

HSCP 68 25 VSCP1 1E8

DON 69 19 MDTH 400E-12

VON 24 5 2.4419107

HSCN 24 69 VSCN1 1.5E8

VSCTHP 60 61 0.1375

DSCP1 61 63 MDTH 400E-12

VSCP1 63 64 0

ISCP 64 0 1.000000E-8

DSCP2 0 64 MDTH 400E-12

DSCN2 0 74 MDTH 400E-12

ISCN 74 0 1.000000E-8

VSCN1 73 74 0

DSCN1 71 73 MDTH 400E-12

VSCTHN 71 70 -0.75

ESCP 60 0 2 1 500

ESCN 70 0 2 1 -2000

.ENDS

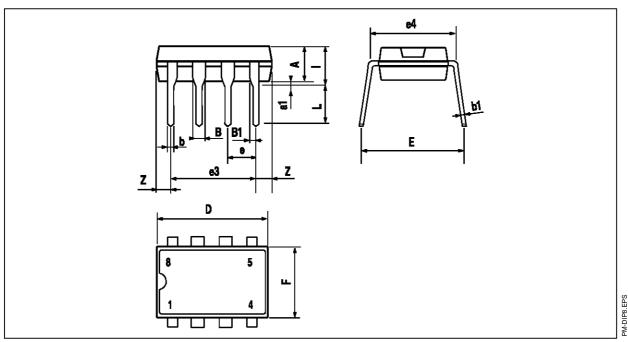
ELECTRICAL CHARACTERISTICS

 V_{CC}^{+} = 10V, V_{CC}^{-} = 0V, R_L , C_L connected to $V_{CC}/2$, T_{amb} = 25°C (unless otherwise specified)

Symbol	Conditions	Value	Unit
Vio		0	mV
A _{vd}	$R_L = 10k\Omega$	20	V/mV
Icc	No load, per operator	350	μΑ
V _{icm}		-0.2 to 10.2	V
Voн	$R_L = 10k\Omega$	9.95	V
VoL	$R_L = 10k\Omega$	50	mV
I _{sink}	V _O = 10V	50	mA
I _{source}	V _O = 0V	50	mA
GBP	$R_L = 10k\Omega$, $C_L = 100pF$	1	MHz
SR	$R_L = 10k\Omega$, $C_L = 100pF$	1	V/μs
Øm	$R_L = 10k\Omega$, $C_L = 100pF$	40	Degrees

PACKAGE MECHANICAL DATA

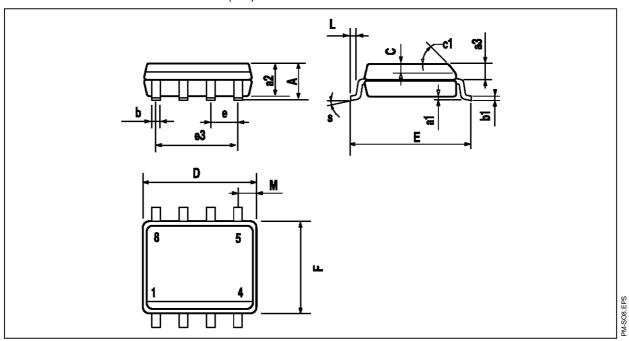
8 PINS - PLASTIC DIP



Dimensions		Millimeters			Inches		
Dillieliaiolia —	Min.	Тур.	Max.	Min.	Тур.	Max.	
А		3.32			0.131		
a1	0.51			0.020			
В	1.15		1.65	0.045		0.065	
b	0.356		0.55	0.014		0.022	
b1	0.204		0.304	0.008		0.012	
D			10.92			0.430	
E	7.95		9.75	0.313		0.384	
е		2.54			0.100		
e3		7.62			0.300		
e4		7.62			0.300		
F			6.6			0260	
i			5.08			0.200	
L	3.18		3.81	0.125		0.150	
Z			1.52			0.060	

PACKAGE MECHANICAL DATA

8 PINS - PLASTIC MICROPACKAGE (SO)



Dimensions -	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			1.75			0.069	
a1	0.1		0.25	0.004		0.010	
a2			1.65			0.065	
a3	0.65		0.85	0.026		0.033	
b	0.35		0.48	0.014		0.019	
b1	0.19		0.25	0.007		0.010	
С	0.25		0.5	0.010		0.020	
c1			45°	(typ.)	•	•	
D	4.8		5.0	0.189		0.197	
E	5.8		6.2	0.228		0.244	
е		1.27			0.050		
e3		3.81			0.150		
F	3.8		4.0	0.150		0.157	
L	0.4		1.27	0.016		0.050	
М			0.6			0.024	
S	_		8° (max.)	•	-	

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